

1017534

https://www.phoenixcontact.com/us/products/1017534

Please be informed that the data shown in this PDF document is generated from our online catalog. Please find the complete data in the user documentation. Our general terms of use for downloads are valid.



PCB terminal block, nominal current: 76 A, rated voltage (III/2): 1000 V, nominal cross section: 16 mm², number of potentials: 5, number of rows: 1, number of positions per row: 5, product range: TDPT 16/..-SP, pitch: 10.16 mm, connection method: Push-in spring connection, mounting: Wave soldering, conductor/PCB connection direction: 0°, color: green, Pin layout: Zigzag pinning W, Solder pin [P]: 3.5 mm, number of solder pins per potential: 2, type of packaging: packed in cardboard

Your advantages

- · Easy to adapt, thanks to their identical size and the same pinning for Push-in spring connections as for screw connections
- · Time saving push-in connection, tools not required
- · Defined contact force ensures that contact remains stable over the long term
- · Intuitive operation due to color-coded actuating push button

Commercial data

Item number	1017534
Packing unit	50 pc
Minimum order quantity	50 pc
Sales key	AA15
Product key	AAOBEA
GTIN	4055626501666
Weight per piece (including packing)	54 g
Weight per piece (excluding packing)	37.88 g
Customs tariff number	85369010
Country of origin	CN



1017534

https://www.phoenixcontact.com/us/products/1017534

Technical data

Product properties

Product type	Printed circuit board terminal
Product family	TDPT 16/SP
Product line	COMBICON Terminals XL
Number of positions	5
Pitch	10.16 mm
Number of connections	5
Number of rows	1
Number of potentials	5
Pin layout	Zigzag pinning W
Solder pins per potential	2

Electrical properties

Nominal current I _N	76 A
Nominal voltage U _N	1000 V
Degree of pollution	3
Rated voltage (III/3)	800 V
Rated surge voltage (III/3)	8 kV
Rated voltage (III/2)	1000 V
Rated surge voltage (III/2)	8 kV
Rated voltage (II/2)	1000 V
Rated surge voltage (II/2)	6 kV

Connection data

Connection technology

Nominal cross section	16 mm²
-----------------------	--------

Conductor connection

Connection method	Push-in spring connection
Conductor cross section rigid	0.75 mm ² 16 mm ² (Conductor connection with open terminal point)
	1.5 mm² 16 mm² (Push-in connection)
Single-conductor/terminal point multi-stranded	0.75 mm² 16 mm²
Conductor cross section flexible	0.75 mm² 16 mm²
Conductor cross section AWG	20 6
Conductor cross section flexible, with ferrule without plastic sleeve	0.75 mm² 16 mm²
Conductor cross section, flexible, with ferrule, with plastic sleeve	0.75 mm² 16 mm²
2 conductors with the same cross section, flexible, with TWIN ferrule with plastic sleeve	0.75 mm² 6 mm²
Stripping length	18 mm



1017534

https://www.phoenixcontact.com/us/products/1017534

Mounting

Mounting type	Wave soldering
Pin layout	Zigzag pinning W
Processing notes	
Process	Wave soldering

Material specifications

Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	Tin-plated
Metal surface terminal point (top layer)	Tin (10 - 16 μm Sn)
Metal surface soldering area (top layer)	Tin (10 - 16 µm Sn)

Material data - housing

Color (Housing)	green (6021)
Insulating material	PA
Insulating material group	I
CTI according to IEC 60112	600
Flammability rating according to UL 94	V0
Glow wire flammability index GWFI according to EN 60695-2-12	850
Glow wire ignition temperature GWIT according to EN 60695-2-13	775
Temperature for the ball pressure test according to EN 60695-10-2	125 °C

Material data - actuating element

Color (Actuating element)	orange (2003)
Insulating material	PA
Insulating material group	I
CTI according to IEC 60112	600
Flammability rating according to UL 94	V0

Dimensions

Dimensional drawing	n n
Pitch	10.16 mm
Width [w]	48.22 mm
Height [h]	34.7 mm



1017534

https://www.phoenixcontact.com/us/products/1017534

Length [I]	31.9 mm
Installed height	31.2 mm
Solder pin length [P]	3.5 mm
Pin dimensions	1.2 x 1 mm
PCB design	
Hole diameter	2 mm

Mechanical tests

Test for conductor damage and slackening

Specification	IEC 60999-1:1999-11
Result	Test passed
Pull-out test	
Specification	IEC 60999-1:1999-11
Conductor cross section/conductor type/tractive force setpoint/actual value	0.75 mm² / solid / > 30 N
	0.75 mm² / flexible / > 30 N
	16 mm² / solid / > 100 N
	16 mm² / flexible / > 100 N

Electrical tests

Temperature-rise test

Specification	IEC 60947-7-4:2013-08
Requirement temperature-rise test	The sum of ambient temperature and temperature rise of the PCB terminal block shall not exceed the upper limiting temperature.
Short-time withstand current	
Specification	IEC 60947-7-4:2013-08
nsulation resistance	
Specification	IEC 60512-3-1:2002-02
Air clearances and creepage distances	
Specification	IEC 60947-1:2007-06 + A1:2010-12 + A2:2014-09
Insulating material group	I
Comparative tracking index (IEC 60112)	CTI 600
Rated insulation voltage (III/3)	800 V
Rated surge voltage (III/3)	8 kV
minimum clearance value - non-homogenous field (III/3)	8 mm
minimum creepage distance (III/3)	10 mm
Rated insulation voltage (III/2)	1000 V
Rated surge voltage (III/2)	8 kV
minimum clearance value - non-homogenous field (III/2)	8 mm
minimum creepage distance (III/2)	8 mm
Rated insulation voltage (II/2)	1000 V



1017534

https://www.phoenixcontact.com/us/products/1017534

Rated surge voltage (II/2)	6 kV
minimum clearance value - non-homogenous field (II/2)	5.5 mm
minimum creepage distance (II/2)	5.5 mm

Environmental and real-life conditions

Vibration test

Specification	IEC 60068-2-6:2007-12
Frequency	10 - 150 - 10 Hz
Sweep speed	1 octave/min
Amplitude	0.35 mm (10 Hz 60.1 Hz)
Acceleration	5g (60.1 Hz 150 Hz)
Test duration per axis	2.5 h

Glow-wire test

Specification	IEC 60695-2-10:2013-04
Temperature	850 °C
Time of exposure	5 s

Aging

Specification	IEC 60947-7-4:2013-08
Ambient conditions	
Ambient temperature (operation)	-40 °C 105 °C (Depending on the current carrying capacity/derating curve)
Ambient temperature (storage/transport)	-40 °C 70 °C
Relative humidity (storage/transport)	30 % 70 %
Ambient temperature (assembly)	-5 °C 105 °C

Packaging specifications

Type of packaging	packed in cardboard

Phoenix Contact 2024 © - all rights reserved https://www.phoenixcontact.com

Phoenix Contact USA 586 Fulling Mill Road Middletown, PA 17057, United States (+717) 944-1300 info@phoenixcon.com